AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions and listings of claims in the application:

LISTING OF THE CLAIMS:

- 1 1. (Currently Amended) A scanning exposure apparatus
- 2 in which a substrate is exposed by synchronously moving a
- 3 mask and the substrate, the apparatus comprising:
- a beam source which emits pulses of an exposure beam
- 5 in response to trigger signals output at predetermined time
- 6 intervals;
- 7 a projection system disposed in a path of the exposure
- 8 beam from the beam source and which projects an image of a
- 9 pattern formed on the mask onto the substrate, the mask to
- 10 be disposed on one side of the projection system and the
- 11 substrate to be disposed on another side thereof;
- 12 a stage disposed on the one side or the other side of
- 13 the projection system and which is movable in a scanning
- 14 direction while holding the mask or the substrate,
- 15 respectively; and
- an interferometer operatively connected to the stage
- 17 and which outputs a measurement value corresponding to

- 18 positional information of the stage in the scanning
- 19 direction; and
- 20 wherein a start timing of the output of the trigger
- 21 signals is controlled based on the measurement value from
- 22 the interferometer
- a controller that controls generation of a series of
- 24 the trigger signals using a time synchronization trigger
- 25 method in which the series of the trigger signals are
- 26 generated at predetermined time intervals, and a start
- 27 timing of the series of trigger signals is determined based
- on the measurement value from the interferometer.
- 1 2. (Currently Amended) A scanning exposure apparatus
- 2 in which a substrate is exposed by synchronously moving a
- 3 mask and the substrate, the apparatus comprising:
- a beam source which emits pulses of an exposure beam
- 5 in response to trigger signals output at predetermined time
- 6 intervals;
- 7 a projection system disposed in a path of the exposure
- 8 beam from the beam source and which projects an image of a
- 9 pattern formed on the mask onto the substrate, the mask to
- 10 be disposed on one side of the projection system and the
- 11 substrate to be disposed on another side thereof;

- 12 a stage disposed on the one side or the other side of
- 13 the projection system and which is movable in a scanning
- 14 direction while holding the mask or the substrate,
- 15 respectively; and
- an interferometer operatively connected to the stage
- 17 and which outputs a measurement value corresponding to
- 18 positional information of the stage in the scanning
- 19 direction; and
- 20 wherein a stop timing of the output of the trigger
- 21 signals is controlled based on the measurement value from
- 22 the interferometer
- 23 a controller that controls generation of a series of
- 24 the trigger signals using a time synchronization trigger
- 25 method in which the series of the trigger signals are
- 26 generated at predetermined time intervals, and a stop
- 27 timing of the series of trigger signals is determined based
- 28 on the measurement value from the interferometer.
 - 3. (Currently Amended) A scanning exposure method in
- 2 which a substrate is exposed by synchronously moving a mask
- 3 and the substrate, the method comprising:

- 4 emitting pulses of an exposure beam from a beam source
- 5 in response to trigger signals output at predetermined time
- 6 intervals;
- 7 moving a stage which holds the mask or the substrate
- 8 in a scanning direction;
- 9 measuring positional information of the stage in the
- 10 scanning direction using an interferometer which outputs a
- 11 measurement value corresponding to the positional
- 12 information of the stage; and
- 13 determining a start timing of the output of the
- 14 trigger signals based on the measurement value from the
- 15 interferometer
- 16 generating a series of the trigger signals using a
- 17 time synchronization trigger method in which the series of
- 18 the trigger signals are generated at predetermined time
- 19 intervals, and a start timing of the series of trigger
- 20 signals is determined based on the measurement value from
- 21 the interferometer.
 - 1 4. (Previously Amended) A scanning exposure method
 - 2 according to claim 3, wherein the beam source emits the
 - 3 pulses of the exposure beam at a predetermined maximum
 - 4 frequency.

- 5. (Original) A scanning exposure method according to
- 2 claim 4, further comprising:
- adjusting a scanning speed of the stage in order to
- 4 supply the substrate with a target exposure amount.
- 1 6. (Original) A scanning exposure method according to
- 2 claim 4, further comprising:
- 3 adjusting intensity of the pulses in order to supply
- 4 the substrate with a target exposure amount.
- 7. (Original) A scanning exposure method according to
- 2 claim 4, further comprising:
- 3 adjusting a width in the scanning direction of an
- 4 illumination area to which the pulses are directed, in
- 5 order to supply the substrate with a target exposure
- 6 amount.
- 8. (Currently Amended) A scanning exposure method in
- 2 which a substrate is exposed by synchronously moving a mask
- 3 and the substrate, the method comprising:

- 4 emitting pulses of an exposure beam from a beam source
- 5 in response to trigger signals output at predetermined time
- 6 intervals;
- 7 moving a stage which holds the mask or the substrate
- 8 in a scanning direction;
- 9 measuring positional information of the stage in the
- 10 scanning direction using an interferometer which outputs a
- 11 measurement value corresponding to the positional
- 12 information of the stage; and
- 13 determining a stop timing of the output of the trigger
- 14 signals based on the measurement value from the
- 15 interferometer
- 16 generating a series of the trigger signals using a
- 17 time synchronization trigger method in which the series of
- 18 the trigger signals are generated at predetermined time
- 19 intervals, and a stop timing of the series of trigger
- 20 signals is determined based on the measurement value from
- 21 the interferometer.
- 9. (Previously Amended) A scanning exposure method
- 2 according to claim 8, wherein the beam source emits the
- 3 pulses of the exposure beam at a predetermined maximum
- 4 frequency.

- 1 10. (Original) A scanning exposure method according
- 2 to claim 8, further comprising:
- 3 adjusting a scanning speed of the stage in order to
- 4 supply the substrate with a target exposure amount.
- 1 11. (Original) A scanning exposure method according
- 2 to claim 8, further comprising:
- 3 adjusting intensity of the pulses in order to supply
- 4 the substrate with a target exposure amount.
- 1 12. (Original) A scanning exposure method according
- 2 to claim 8, further comprising:
- 3 adjusting a width in the scanning direction of an
- 4 illumination area to which the pulses are directed, in
- 5 order to supply the substrate with a target exposure
- 6 amount.
- 1 13. (Currently Amended) A laser apparatus used with a
- 2 scanning exposure system in which a mask and a substrate
- 3 are moved during scanning exposure of the substrate, the
- 4 laser apparatus comprising:

- 5 a beam source which emits pulses of an exposure beam
- 6 in response to trigger signals output at predetermined time
- 7 intervals; and
- 8 wherein a start timing of the output of the trigger
- 9 signals is controlled based on a measurement value from an
- 10 interferometer which measures positional information of the
- 11 mask or the substrate
- a controller that controls generation of a series of
- 13 the trigger signals using a time synchronization trigger
- 14 method in which the series of the trigger signals are
- 15 generated at predetermined time intervals, and a start
- 16 timing of the series of trigger signals is determined based
- 17 on measurement values from an interferometer which measures
- 18 positional information of the mask or the substrate.
- 1 14. (Currently Amended) A laser apparatus used with a
- 2 scanning exposure system in which a mask and a substrate
- 3 are moved during scanning exposure of the substrate, the
- 4 laser apparatus comprising:
- 5 a beam source which emits pulses of an exposure beam
- 6 in response to trigger signals output at predetermined time
- 7 intervals; and

- 8 wherein a stop timing of the output of the trigger
- 9 signals is controlled based on a measurement value from an
- 10 interferometer which measures positional information of the
- 11 mask or the substrate
- 12 a controller that controls generation of a series of
- 13 the trigger signals using a time synchronization trigger
- 14 method in which the series of the trigger signals are
- 15 generated at predetermined time intervals, and a stop
- 16 timing of the series of trigger signals is determined based
- 17 on measurement values from an interferometer which measures
- 18 positional information of the mask or the substrate.
- 1 15. (Currently Amended) A device manufacturing method
- 2 including scanning exposure process in which a substrate is
- 3 exposed by synchronously moving a mask and the substrate,
- 4 the method comprising:
- 5 emitting pulses of an exposure beam from a beam source
- 6 in response to trigger signals output at predetermined time
- 7 intervals;
- 8 moving a stage which holds the mask or the substrate
- 9 in a scanning direction;
- 10 measuring positional information of the stage in the
- 11 scanning direction using an interferometer which outputs a

- 12 measurement value corresponding to the positional
- 13 information of the stage; and
- 14 determining a start timing of the output of the
- 15 trigger signals based on the measurement value from the
- 16 interferometer
- 17 generating a series of the trigger signals using a
- 18 time synchronization trigger method in which the series of
- 19 the trigger signals are generated at predetermined time
- 20 intervals, and a start timing of the series of trigger
- 21 signals is determined based on the measurement value from
- 22 the interferometer.
- 1 16. (Currently Amended) A device manufacturing method
- 2 including scanning exposure process in which a substrate is
- 3 exposed by synchronously moving a mask and the substrate,
- 4 the method comprising:
- 5 emitting pulses of an exposure beam from a beam source
- 6 in response to trigger signals output at predetermined time
- 7 intervals;
- 8 moving a stage which holds the mask or the substrate
- 9 in a scanning direction;
- 10 measuring positional information of the stage in the
- 11 scanning direction using an interferometer which outputs a

- 12 measurement value corresponding to the positional
- 13 information of the stage; and
- 14 determining a stop timing of the output of the trigger
- 15 signals based on the measurement value from the
- 16 interferometer
- 17 generating a series of the trigger signals using a
- 18 time synchronization trigger method in which the series of
- 19 the trigger signals are generated at predetermined time
- 20 intervals, and a stop timing of the series of trigger
- 21 signals is determined based on the measurement value from
- 22 the interferometer.
- 1 17. (Currently Amended) A scanning exposure method
- 2 according to claim 3, further comprising:
- 3 rotating adjusting an optical member disposed in the
- 4 path of the exposure beam, in order to adjust an intensity
- 5 distribution of the exposure beam in a non-scanning
- 6 direction perpendicular to the scanning direction.
- 1 18. (Previously Added) A scanning exposure method
- 2 according to claim 17, wherein the exposure beam has an
- 3 intensity distribution in the scanning direction, wherein

- 4 the intensity distribution in the scanning direction has
- 5 slope portions at the edges thereof.
- 1 19. (Currently Amended) A scanning exposure method
- 2 according to claim 17, wherein the optical member includes
- 3 a field an adjustable stop.
- 1 20. (Currently Amended) A scanning exposure method
- 2 according to claim 8, further comprising:
- 3 rotating adjusting an optical member disposed in the
- 4 path of the exposure beam, in order to adjust an intensity
- 5 distribution of the exposure beam in a non-scanning
- 6 direction perpendicular to the scanning direction.
- 1 21. (Previously Added) A scanning exposure method
- 2 according to claim 20, wherein the exposure beam has an
- 3 intensity distribution in the scanning direction, wherein
- 4 the intensity distribution in the scanning direction has
- 5 slope portions at the edges thereof.
- 1 22. (Currently Amended) A scanning exposure method
- 2 according to claim 20, wherein the optical member includes
- 3 a field an adjustable stop.